

2827

TRANSMITTAL FORM

Application Number	09/786,597
Filing Date	February 28, 2001
First Named Inventor	Kenichi HIRAHARA
Title	Through Hole Conduction Structure of Flexible Multilayer Circuit Board and Forming Method Thereof
Group Art Unit	2827
Examiner Name	Tuan T. DINH
Attorney Docket Number	KAM/133/PC/US

ENCLOSURES

TO: Commissioner For Patents
Washington, DC 20231

- ☒ RESPONSE TO OFFICE ACTION
- ☐ Preliminary Amendment
- ☐ Information Disclosure Statement
- ☒ Postcard Reflecting Enclosures
- ☐ Other:
- ☒ It is hereby petitioned that any required extension of time be granted for filing the Amendment. An extension of -0- month(s) having a fee of \$ -0- appears required.
- ☒ A check in the amount of \$ -0- is attached. Please credit any overpayment to Deposit Account 16-2563 of Alix, Yale & Ristas, LLP.

The Commissioner is hereby requested and authorized to charge Deposit Account 16-2563 of Alix, Yale & Ristas, LLP for any fee, not enclosed herewith, due for any reason in connection with the amendment or this or any other document accompanying the amendment, including (a) any filing fees under 37 CFR 1.16 for the presentation of extra claims and (b) any patent application processing fees under 37 CFR 1.17. ☒ **A duplicate copy of this sheet is attached.**

SIGNATURE OF APPLICANT, ATTORNEY OR AGENT

Firm or Individual name	Guy D. Yale
Signature	
Date	1-31-2003

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CERTIFICATE OF MAILING

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Typed or Printed Name	Guy D. Yale	Reg. No.	29,125
Signature		Date:	1-31-2003



ATTORNEY DOCKET NO. KAM/133/PC/US
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Title: Through Hole Conduction Structure of Flexible Multilayer Circuit Board and Forming Method Thereof

Commissioner for Patents
United States Patent and Trademark Office
Washington, DC 20231

Sir:

RESPONSE TO OFFICE ACTION

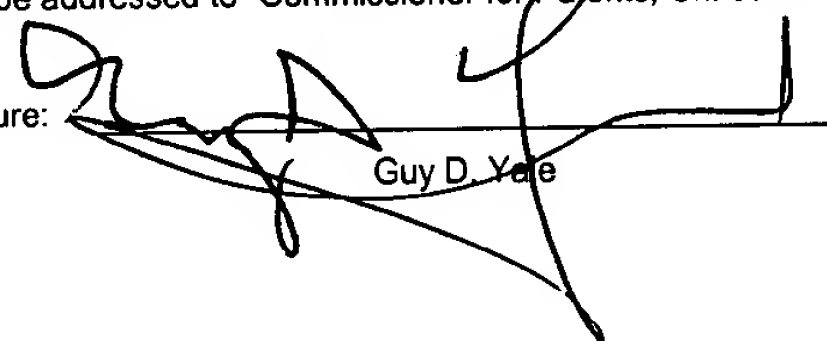
In response to the Office Action dated November 13, 2002, Applicant respectfully requests entry and consideration of the following Amendment and Remarks and reconsideration and allowance of all claims.

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Attorney's Ref: KAM/133/PC/US

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Signature: 
Guy D. Yale

Reg. No.: 29,125

Date: January 31, 2003